

C1210X471KGGACTU

Aliases (C1210X471KGGAC7800) SMD Comm COG HV Flex, Ceramic, 470 pF, 10%, 2,000 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1210, 1.5 mm



Click here for the 3D model.

1000

General Information	
Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	95 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		Specifications
Chip Size	1210	Capacitance
L	3.3mm +/-0.4mm	Measurement Condition
W	2.6mm +/-0.3mm	Tolerance
т	2.5mm +/-0.30mm	Voltage DC
S	1.5mm MIN	Dielectric Withstanding Voltage
В	0.6mm +/-0.25mm	Temperature Range
		Temp. Coefficient
Packaging Specifications		Capacitance Change with
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC

Specifications	
Capacitance	470 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	10%
Voltage DC	2000 VDC
Dielectric Withstanding Voltage	2,400 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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Packaging Quantity